



Single-FET, Constant Power-Limit Hot Swap Controller

### **General Description**

The MIC2310 is a single-channel, positive voltage, constant power-limit hot swap controller designed to provide for the safe insertion and removal of pc boards into fixed, rack, and pedestal mid- or back-planes using few external components. In addition, the MIC2310 employs a patent-pending, output load power-limiting technique where the current limit is inversely proportional to the output load voltage, such that the power product will not exceed the programmed power limit any longer than the externally programmed primary overcurrent period. The MIC2310 is ideally suited to address the power-limiting and timing requirements per the UL60950 specification for 240-VA applications. The MIC2310 incorporates high-side controller circuitry for an external N-channel MOSFET for which the MOSFET drain current rate of change is userprogrammable via an external capacitor. The MIC2310 dual-speed, dual-level overcurrent fault employs protection. The primary overcurrent detector response time is programmable via an external current sense resistor and the secondary overcurrent detector is 2-bit userprogrammable and exhibits a very fast (default) response to faults to ensure that the system power supplies are protected against catastrophic load current and shortcircuit faults. Additionally, an analog output (voltage) signal is provided that is proportional to the steady-state load current to allow monitoring of the system's power. A PWRGD signal is provided to indicate a valid output voltage that can be used to enable a DC-DC power module.

Data sheets and support documentation can be found on Micrel's web site at www.micrel.com.

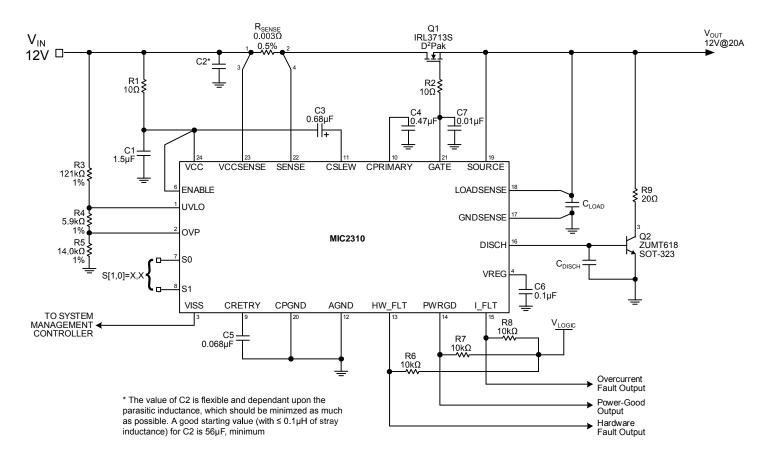
#### Features

- Provides safe PCB insertion and removal from live +12V backplanes
- Patent-pending, adaptive circuit breaker threshold control
  - Maintains constant power product at output
  - Power-limit product (VA) is externally programmable for various power applications
- Dual-level, dual-speed overcurrent detection/protection
  - Programmable primary detector response time
    - Fast (< 1 μs) secondary detector response time to short circuit conditions
      - User-programmable threshold settings via (2) digital inputs
- Steady-state load current monitoring
- Programmable inrush current slew-rate control
- Electronic circuit breaker functions after fault
  - Latch off
  - Automatic retry
- Programmable input undervoltage lockout and overvoltage protection
- Fault reporting:
  - Open-drain 'Power-is-Good' output
  - Open-drain 'I\_FLT' output signaling for all current faults
  - Shorted R<sub>SENSE</sub> and Damaged MOSFET detection (D-G and D-S shorts)

### Applications

- UL60950, EN60950, and CSA1950 systems (240-VA)
- General Power-limiting Applications
- Base stations
- Enterprise servers
- High-reliability servers
- Enterprise switch networks
- +12V backplanes

## **Typical Application**

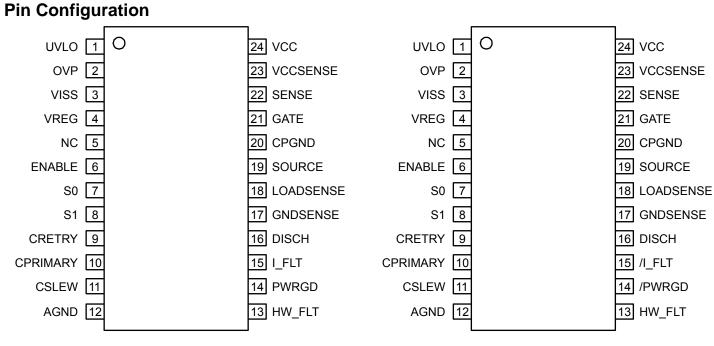


### **Ordering Information**

| Part Number  | PWRGD State | I_FLT State | Fault Condition Status | Package      | Lead Finish |
|--------------|-------------|-------------|------------------------|--------------|-------------|
| MIC2310-1ZTS | Active-HIGH | Active-HIGH | Latched/Auto-retry     | 24-pin TSSOP | Pb-Free     |
| MIC2310-2ZTS | Active-LOW  | Active-LOW  | Latched/Auto-retry     | 24-pin TSSOP | Pb-Free     |

Note:

1. Other Voltage available. Contact Micrel for details.



24-pin TSSOP (TS) MIC2310-1ZTS

24-pin TSSOP (TS) MIC2310-2ZTS

| Pin Number | Pin Name | Pin Function   |
|------------|----------|--|
| 1          | UVLO     | Undervoltage Lockout Input. When the applied voltage at the UVLO pin is higher than the controller's $V_{UVLOH}$ threshold voltage, the GATE drive circuits are active when ENABLE= HIGH. If the applied voltage at the UVLO pin falls below the controller's $V_{UVLOL}$ threshold voltage, the GATE drive circuits are disabled to turn the external MOSFET OFF. In addition, the DISCH circuit is activated to drive an optional, external discharge transistor alone (illustrated in the Typical Application circuit) or in combination with an SCR for a very fast discharge circuit configuration.   |
| 2          | OVP      | Overvoltage Protection Input. When the applied voltage at the OVP pin is higher than the controller's $V_{OVPH}$ threshold voltage, the GATE drive circuit is disabled to turn the external MOSFET OFF. In addition, the DISCH circuit is activated to drive an optional, external discharge transistor alone (illustrated in the Typical Application circuit) or in combination with an SCR for a very fast discharge circuit configuration. Using an external resistor divider, the UVLO and the OVP pins form a window comparator that defines the supply voltage range within which the load may be safely powered.  |
| 3          | VISS     | Steady-state Output Current Monitor. This output signal provides an analog voltage that is proportional to the steady-state load current. This signal is provided as an input to the system supervisor/processor to monitor the dc current/power level of the application circuit.   |
| 4          | VREG     | Internal +5V Regulator Bypass. Connect a 0.1- $\mu$ F, 16V ceramic capacitor from this pin to AGND.  |
| 5          | NC       | No connection  |
| 6          | ENABLE   | ENABLE Input. An active asserted-HIGH digital input that controls the operation of the MIC2310. Activated after the internal POR timer has terminated, a LOW-to-HIGH transition on this pin commences a start-up sequence if the applied V <sub>CC</sub> is above the V <sub>UVLOH</sub> and below the V <sub>OVPH</sub> threshold voltages. While ENABLE = LOW, the GATE pin is held to 0V and the DISCH output is activated. The ENABLE input can be used to reset the internal circuit breaker by applying a HIGH-to-LOW-to-HIGH transition as defined by t <sub>ENLPW</sub> following either a load current fault, an open LOADSENSE fault, an open GNDSENSE fault, or a shorted RSENSE fault. |
| 7          | S0       | Secondary OC Detector Current Threshold Digital Inputs – S1 is the MSB and   |
| 8          | S1       | S0 is the LSB. When used together, S[1:0] sets the overcurrent threshold for the secondary overcurrent detection circuit to one of four levels relative to the primary overcurrent detector nominal threshold. For example, S[1:0] = L, L sets the secondary overcurrent threshold at 1.3X; S[1:0] = L, H sets a 1.5X threshold; S[1:0] = H, L sets a 2X threshold, and S[1:0] = H, H sets a 1.75X threshold. If the S[1:0] pins are not connected or left NC, the default setting is S[1:0] = L, L or 1.3X. The permissible voltage range on these inputs is AGND $\leq$ S[1:0] $\leq$ V <sub>CC</sub> .  |
| 9          | CRETRY   | Auto-retry Timing Capacitor. A capacitor connected from the CRETRY pin to AGND configures the MIC2310 to re-start automatically with ENABLE = HIGH after the circuit breaker trips and latches off. It also sets the "cool-off" time delay before a new load current start-up sequence is initiated. To configure the MIC2310's circuit breaker to latch off after fault, connect this pin to AGND. The circuit breaker latches OFF and remains latched OFF unless the ENABLE input is toggled HIGH-to-LOW-to-HIGH as defined by $t_{ENLPW}$ or the V <sub>CC</sub> supply voltage is turned OFF then ON.  |
| 10         | CPRIMARY | Primary Overcurrent Detector Timing Capacitor. Connecting a capacitor from the CPRIMARY pin to AGND sets the response time of the controller's primary overcurrent detection circuit to GATE OFF in the event of an overcurrent condition. If the CPRIMARY pin is not connected, the primary overcurrent detection response time defaults to t <sub>POCSENSE</sub> , typically 250µs as specified in the Electrical Characteristics Table. The controller incorporates a patent-pending built-in test for a faulty CPRIMARY capacitor.   |

## Pin Description (continued)

| Pin Number | Pin Name        | Pin Function  |
|------------|-----------------|---|
| 11         | CSLEW           | Inrush Current Slew Rate Control Input. To adjust the inrush load current profile (controlled $dl_{DRAIN}/dt$ ), connect a capacitor from this pin to VCC. To adjust the MOSFET GATE voltage profile (controlled $dV_{GATE}/dt$ ), leave this pin OPEN (floating) and connect a capacitor from GATE to AGND. For additional information on the operation of this function, please refer to the Functional Description section.  |
| 12         | AGND            | Analog Ground. Connect this pin to the system analog ground plane.  |
| 13         | HW_FLT          | External MOSFET Hardware Fault Digital Output. This output is an open-drain, active-HIGH signal that should be connected to a +3.3V logic supply by a 10k $\Omega$ resistor. This digital output is active after the internal POR timer has terminated and becomes asserted (HIGH) due to a fault under the following conditions: a) a shorted DG MOSFET with ENABLE = LOW; b) a shorted DS MOSFET with ENABLE = LOW; c) a shorted R <sub>SENSE</sub> ; d) a shorted DS MOSFET after steady-state operation with ENABLE = HIGH-to-LOW; or e) a shorted DG or DS while EN = HIGH and DISCH = HIGH; or f) a shorted C <sub>PRIMARY</sub> to AGND. The HW_FLT output is latched and is reset when VCC is brought low such that |
|            |                 | $V_{\text{REG}} < V_{\text{VREG}(UVLO)}.$   |
| 14         | PWRGD<br>/PWRGD | Power Good Digital Output. This output is an open-drain, active-HIGH (PWRGD) or active-LOW (/PWRGD) signal that should be connected to a +3.3-V logic supply by a 10k $\Omega$ resistor. This digital output is active after the internal POR timer has terminated and becomes asserted when the voltage between the LOADSENSE and the GNDSENSE pins is higher than the controller's V <sub>PGH</sub> threshold voltage. It is de-asserted when the voltage between the LOADSENSE and the GNDSENSE pins is less than the controller's V <sub>PGL</sub> threshold voltage.   |
| 15         | I_FLT<br>/I_FLT | Load Current Fault Digital Output. This output is an open-drain, active-HIGH (I_FLT) or active-LOW (/I_FLT) signal that should be connected to a +3.3V logic supply by a 10k $\Omega$ resistor. This digital output is active after the internal POR timer has terminated and becomes asserted whenever the primary or secondary overcurrent detection circuits cause the internal circuit breaker to latch OFF. The digital output remains asserted unless the ENABLE input is toggled HIGH-to-LOW-to-HIGH as defined by t <sub>ENLPW</sub> or the V <sub>CC</sub> supply voltage is turned OFF then ON or if the auto-retry mode is enabled.  |
| 16         | DISCH           | Discharge External Transistor Drive Output. When ENABLE = LOW or after a fault condition (either an overcurrent fault or hardware fault such as a shorted MOSFET) that causes either the primary and secondary overcurrent detectors to trip the internal circuit breaker, the DISCH circuit is activated to provide gate drive to optional, external transistors (and SCR, for very fast load discharge). These transistors serve as auxiliary gate pull-down or load voltage pull-down switches. A load voltage pull-down is illustrated in the Typical Application circuit.  |
| 17         | GNDSENSE        | These input pins (when used together) sense the load voltage and provide  |
| 18         | LOADSENSE       | feedback to the controller's adaptive VA limit and Power-Good circuits. The voltage across these two pins also sets the controller's Power-Is-Good status output as defined by the specified V <sub>PGH</sub> or the V <sub>PGL</sub> threshold voltages. Internal circuit monitors are included if either or both LOADSENSE and GNDSENSE connections are severed or not connected to the load.   |
| 19         | SOURCE          | External Power MOSFET Source Pin Monitor. To protect external circuits downstream of the controller, internal monitor circuits are included to sense a shorted drain-source condition of the external power MOSFETs.  |
| 20         | CPGND           | Internal charge pump power ground. Connect this pin directly to the system's analog ground plane.   |
| 21         | GATE            | External N-channel MOSFET GATE Drive Output. The GATE output signal uses an internal charge pump to charge the gate of an external N-channel MOSFET pass transistor.  |

## Pin Description (continued)

| Pin Number | Pin Name | Pin Function  |
|------------|----------|---|
| 22         | SENSE    | By connecting a very low value (m $\Omega$ ) current sense resistor between these two   |
| 23         | VCCSENSE | pins, the MIC2310's internal primary and secondary overcurrent detection circuits monitor the load current. The VCCSENSE pin is the positive (+) input terminal and the SENSE pin is the negative (-) input terminal of the overcurrent detection circuits. If the voltage across the sense resistor exceeds either the primary overcurrent threshold for a time ( $t_{POC}$ ) or the secondary primary overcurrent threshold for any duration, the MIC2310 electronic circuit breaker is tripped, the GATE is turned OFF, the DISCH circuit is activated, and the I_FLT digital output is asserted. The controller also incorporates a patent-pending built-in test for shorted current-sense resistors. Because of this built-in self test, the MIC2310's electronic circuit breaker cannot be disabled by connecting together the VCCSENSE and SENSE pins. |
| 24         | VCC      | Positive supply input to the MIC2310. The MIC2310 is specified to operate from $+10.8V \le V_{CC} \le +13.2V$ and the supply current with ENABLE = HIGH is less than 10mA.  |

| VCC, VCCSENSE, SENSE, LOADSENSE, ENABLE,<br>CSLEW, S1, S0, SOURCE0.3V to +18V |
|---|
| GATE–0.3V to +30V   |
| UVLO, OVP, VISS, CRETRY, CPRIMARY, HW_FLT,                                    |
| PWRGD, I_FLT, DISCH, GNDSENSE –0.3V to +6V                                    |
| Output Current  |
| HW_FLT, PWRGD, I_FLT pins10mA   |
| ESD Rating (All pins)   |
| Human Body Model 2kV <sup>(3)</sup>   |
| Machine Model   |
| Lead Temperature (Soldering) Pb-free package                                  |
| IR Reflow+260°C +0°C/-5°C   |
| Storage Temperature65°C to +150°C   |
|   |

## **Operating Ratings**<sup>(2)</sup>

| Supply Voltage (V <sub>CC</sub> )            | +10.8V to +13.2V |
|--|------------------|
| Ambient Temperature Range (T <sub>A</sub> )  | 0 °C to +70 °C   |
| Junction Temperature (T <sub>J</sub> )       | +125 °C          |
| Package Thermal Resistance ( $\theta_{JA}$ ) |                  |
| 24-pin TSSOP                                 | 83.8 °C/W        |

## DC Electrical Characteristics<sup>(4)</sup>

 $V_{CC}$  = +12V,  $C_{REG}$  = 0.1µF,  $T_A$  = +25 °C unless otherwise noted. **Bold** indicates specification applies over the full operating temperature range of 0 °C to +70 °C. All voltages are measured with respect to AGND unless otherwise noted.

| Symbol                          | Parameter  | Condition   | Min   | Тур   | Max   | Units |
|---------------------------------|--|---|-------|-------|-------|-------|
| V <sub>CC</sub>                 | Operating Supply Voltage<br>(Constant Output Power)                                    |   | 10.8  |       | 13.2  | V     |
| I <sub>CC</sub>                 | Supply Current   | ENABLE = LOW,HIGH   |       |       | 10    | mA    |
| $V_{\text{VREG}(\text{UVLOH})}$ | Internal VREG Undervoltage<br>Lockout High Threshold<br>Voltage                        | V <sub>REG</sub> Low-to-High Transition   | 3.95  | 4.25  | 4.5   | V     |
| $V_{\text{VREG}(\text{UVLOL})}$ | Internal V <sub>REG</sub> Undervoltage<br>Lockout Low Threshold<br>Voltage             |   | 3.70  |       | 4.25  | V     |
| V <sub>UVLOH</sub>              | UVLO High Threshold<br>Voltage   | Low-to-High Transition  | 0.96  | 1.00  | 1.04  | V     |
| V <sub>UVLOL</sub>              | UVLO Low Threshold<br>Voltage  | High-to-Low Transition  | 0.91  | 0.941 | 0.97  | V     |
| I <sub>UVLO</sub>               | UVLO Pin Input Current   | UVLO = 6V   |       |       | 5     | μA    |
| V <sub>OVPH</sub>               | OVP High Threshold Voltage   | Low-to-High Transition  | 1.35  | 1.407 | 1.45  | V     |
| V <sub>OVPL</sub>               | OVP Low Threshold Voltage  | High-to-Low Transition  | 1.295 | 1.339 | 1.395 | V     |
| I <sub>OVP</sub>                | OVP Pin Input Current  | OVP = 6V  |       |       | 5     | μA    |
| V <sub>GSPGH</sub>              | "Power-is-Good" GATE-<br>SOURCE Threshold  | (V <sub>GATE</sub> – V <sub>SOURCE</sub> )  | 4.25  | 5     |       | V     |
| V <sub>PGH</sub>                | "Power-is-Good" High<br>Threshold<br>(V <sub>LOADSENSE</sub> – V <sub>GNDSENSE</sub> ) | Low-to-High Transition,<br>(V <sub>GATE</sub> – V <sub>SOURCE</sub> ) ≥ V <sub>GSPGH</sub><br>Measured with respect to<br>GNDSENSE = AGND | 9.3   | 9.7   | 10.1  | V     |
| V <sub>PGL</sub>                | "Power-not-Good" Low<br>Threshold<br>(V <sub>LOADSENSE</sub> – V <sub>GNDSENSE</sub> ) | High-to-Low Transition,<br>$(V_{GATE} - V_{SOURCE}) \ge V_{GSPGH}$ Measured<br>with respect to GNDSENSE = AGND                            | 8.4   | 9     | 9.6   | V     |
| V <sub>REG</sub>                | V <sub>REG</sub> Output Voltage  | R <sub>REG</sub> > 1 MΩ   | 4.5   | 5     | 5.5   | V     |

| Symbol              | Parameter  | Condition   |  | Min   | Тур   | Max                        | Units |
|---------------------|--|---|--|-------|-------|----------------------------|-------|
| V <sub>CBP</sub>    | Primary OC Circuit Breaker                           | (V <sub>LOADSENSE</sub> – V <sub>GI</sub>   | <sub>NDSENSE</sub> ) = +12V  | 54.7  | 57.2  | 59.7                       | mV    |
|                     | Threshold Voltage                                    | (V <sub>LOADSENSE</sub> – V <sub>G</sub>  | <sub>NDSENSE</sub> ) = +10.8V  | 60.7  | 63.5  | 66.3                       | mV    |
|                     | $V_{VCCSENSE} - V_{SENSE}$                           | (V <sub>LOADSENSE</sub> – V <sub>G</sub>  | <sub>NDSENSE</sub> ) = +13.2V  | 49.6  | 51.9  | 54.2                       | mV    |
| V <sub>CBS</sub>    | Secondary OC SENSE                                   | Secondary OC  | S[1:0] = L, L  | 64    | 75.5  | 87                         | mV    |
|                     | Voltage  | Detector Circuit  | S[1:0] = L, H  | 75    | 87.5  | 99                         | mV    |
|                     | $V_{VCCSENSE}$ - $V_{SENSE}$                         | Breaker Trips,<br>V <sub>LOADSENSE</sub> –  | S[1:0] = H, L  | 100   | 116.6 | 59.7<br>66.3<br>54.2<br>87 | mV    |
|                     |  | V <sub>GNDSENSE</sub> =<br>10.8V to 13.2V   | S[1:0] = H,H   | 85    | 102   |                            | mV    |
| IVCCSENSE           | VCCSENSE Pin Input<br>Current                        | $V_{VCCSENSE} = V_{CC}$   |  |       |       | 1                          | μA    |
| I <sub>SENSE</sub>  | SENSE Pin Input Current                              | $V_{SENSE} = V_{CC}$  |  |       |       | 3                          | μA    |
| V <sub>RETRYH</sub> | CRETRY Pin High<br>Threshold Voltage                 |   |  | 1.21  | 1.25  | 1.28                       | V     |
| V <sub>RETRYL</sub> | CRETRY Pin Low Threshold<br>Voltage                  |   |  | 0.25  | 0.3   | 0.35                       | V     |
| IRETRYUP            | CRETRY Pin Charging<br>Current                       | TIMER ON,<br>V <sub>RETRY</sub> = 0V  |  | -4.25 | -3    | -1.65                      | μA    |
| IRETRYDN            | CRETRY Pin Pull-down<br>Current                      | TIMER OFF,<br>V <sub>RETRY</sub> = 1.5V   |  |       | 3     |                            | mA    |
| V <sub>PRIL</sub>   | CPRIMARY Pin Low<br>Threshold Voltage                | During OC respo<br>ENABLE = HIGH<br>V <sub>CC(SENSE)</sub> – V <sub>SEN</sub><br>Measured relativ | I;<br><sub>SE</sub> > V <sub>CBP</sub>                                       | -1.3  | -1.25 | -1.2                       | V     |
| V <sub>PRIL</sub>   | CPRIMARY Pin Low<br>Threshold Voltage                | During shorted<br>C <sub>PRIMARY</sub><br>detection;<br>Measured<br>relative to V <sub>REG</sub>  | ENABLE = HIGH;<br>$V_{CC(SENSE)} - V_{SENSE}$<br>$< V_{CBP}$<br>ENABLE = LOW | -1.3  | -1.25 | -1.2                       | V     |
| I <sub>PRI</sub>    | CPRIMARY Pin Charging<br>Current                     | During Primary C<br>$V_{CPRIMARY} = V_{REG}$<br>ENABLE = HIGH<br>$V_{CC(SENSE)} - V_{SEN}$        | ;<br>1   | 2.4   | 3     | 3.6                        | μA    |
|                     |  | During nominal a $V_{PRIMARY} = V_{REG} - ENABLE = HIGH V_{CC(SENSE)} - V_{SEN}$                  | 1  | -4.5  | -3    | -1.5                       | mA    |
|                     |  | During disable;<br>V <sub>CPRIMARY</sub> = V <sub>REG</sub><br>ENABLE = LOW                       | – 1.25V  | -4.5  | -3    | -1.5                       | mA    |
| $\Delta V_{GATE}$   | GATE Output Voltage                                  | (V <sub>GATE</sub> -V <sub>CC</sub> ): V <sub>CC</sub><br>Internally clampe                       |  | 8     |       | 15                         | V     |
| $\Delta V_{CP}$     | V <sub>CSLEW</sub> – V <sub>SENSE</sub> Differential | Charge pump to  | OFF  |       | 50    |                            | mV    |
| I <sub>SLEW</sub>   | Inrush Current slew<br>Charging current              | $V_{CSLEW} = V_{CC} - 5$  | 0mV  | 5     | 10    | 15                         | μA    |

| Symbol                      | Parameter  | Condition   | Min  | Тур | Max  | Units |
|-----------------------------|--|---|------|-----|--|-------|
| IGATEUP                     | GATE Pin Pull-up Current   | Charge pump ON,   | -60  | -30 | -15  | μA    |
|                             |  | $V_{GATE} = V_{SOURCE} = +13.2V$  |      |     |  |       |
|                             | Normal GATE Pin Pull-down  | ENABLE = LOW,   | 1.0  | 2.7 | -15<br>4.5<br>4.5<br>18<br>1.5<br>18<br>300<br>300<br>300<br>300<br>300<br>300<br>300<br>103 | mA    |
|                             | Current  | $V_{GATE} = 2V$   |      |     |  |       |
|                             | Fault-mode GATE Pin Pull-  | I_FLT Latched and OC Detector Trip  | 45   | 120 |  | mA    |
|                             | down current   | or in UVLO, V <sub>GATE</sub> = 2V  |      |     |  |       |
| $V_{GATEFT(EXT)}$           | GATE-to-AGND Fault   |   |      | 5   |  | V     |
|                             | Threshold<br>ENABLE = LOW  |   |      |     |  |       |
| V                           |  |   |      | F   |  | V     |
| V <sub>SRCFT(EXT)</sub>     | SOURCE-to-AGND Fault   |   |      | 5   |  | V     |
|                             | ENABLE = LOW   |   |      |     |  |       |
| VTHLOADSENSE                | Open LOADSENSE   | V <sub>SOURCE</sub> - V <sub>LOADSENSE</sub>  |      | 4   |  | V     |
| MECADOLINOL                 | Threshold  |   |      |     |  |       |
| VTHGNDSENSE                 | Open GNDSENSE  | V <sub>GNDSENSE</sub>   |      | 4   |  | V     |
|                             | Threshold  |   |      |     |  |       |
| ISOURCE                     | SOURCE Pin Input Current   | EN = LOW, $0V \le SOURCE \le V_{CC}$  |      |     | 18<br>1.5<br>18<br>300<br>300<br>300<br>300<br>  | μA    |
|                             |  | EN = HIGH, SOURCE = V <sub>CC</sub>   |      |     |  | μA    |
|                             |  | EN = HIGH, /FAULT Condition   |      |     | 18   | μA    |
|                             |  | $0V \le SOURCE \le V_{CC}$  |      |     |  |       |
|                             | LOADSENSE Pin Input  | $+10.8V \le V_{LOADSENSE} \le +13.2V$   |      |     | 1.5<br>18<br>300<br>300<br>  | μA    |
|                             | Current  | V <sub>LOADSENSE</sub> = 0V   |      |     |  | μA    |
|                             |  | DISCH = HIGH  |      |     |  |       |
|                             | GNDSENSE Pin Input   | V <sub>GNDSENSE</sub> = 0V  | -400 |     |  | μA    |
|                             | Current  |   |      |     |  |       |
| $\Delta V_{\text{DS(FET)}}$ | Shorted R <sub>SENSE</sub> Threshold                                     | $V_{CC(SENSE)} - V_{SENSE} = 0V,$   |      | 7   |  | mV    |
|                             | Voltage at SOURCE  | $V_{GATE} - V_{SOURCE} > V_{GSPGH}$   |      |     |  |       |
|                             | (V <sub>SENSE</sub> – V <sub>SOURCE</sub> )                              |   |      |     |  |       |
| $\Delta V_{RSENSE}$         | Shorted R <sub>SENSE</sub> Threshold                                     | $V_{\text{SENSE}} - V_{\text{SOURCE}} = 30 \text{mV},$                              |      | 12  |  | mV    |
|                             | Voltage  | $V_{GATE} - V_{SOURCE} > V_{GSPGH}$   |      |     |  |       |
| V                           | (V <sub>VCCSENSE</sub> – V <sub>SENSE</sub> )<br>DISCH Pin Drive Voltage |   |      |     | 0.4  | V     |
| V <sub>DISCH</sub>          | DISCH Pin Drive Current  | $I_{\text{DISCH}} = 12\text{mA}$  |      |     |  | -     |
|                             |  | $V_{\text{DISCH}} = 2.5V$   | 0    |     |  | μA    |
| V <sub>ISS(LIN)</sub>       | Linear Sensing Range   | V <sub>VCC(SENSE)</sub> - V <sub>SENSE</sub>  | 0    |     |  | mV    |
| $V_{ISS(Q)}$                | Zero Voltage VISS Output<br>Voltage                                      | $V_{VCC(SENSE)} - V_{SENSE} = 0mV$  | 7    | 55  | 103  | mV    |
| R <sub>VISS</sub>           | VISS DC Output Resistance  | [VISS <sub>(20μA)</sub> -VISS <sub>(10μA)</sub> ]/10μA                              |      | 100 |  | kΩ    |
| $V_{ISS(SENS)}$             | VISS Analog Signal<br>Sensitivity  | $\Delta V_{\text{VISS}} / \Delta (V_{\text{VCC}(\text{SENSE})} - V_{\text{SENSE}})$ | 28   | 30  | 32   | V/V   |
| E <sub>TOT</sub>            | VISS Total Error % (240 VA)  | V <sub>VCC(SENSE)</sub> - V <sub>SENSE</sub> = 60mV                                 |      |     | ±10  | %     |

| Symbol           | Parameter  | Condition                                    | Min | Тур | Мах  | Units |
|------------------|--|--|-----|-----|------|-------|
| E <sub>LIN</sub> | VISS Analog Nonlinearity                         | $V_{VCC(SENSE)}$ - $V_{SENSE}$ = 0mV to 90mV |     |     | ±6.5 | %     |
| V <sub>OL</sub>  | LOW-Level Output Voltage<br>I_FLT, PWRGD, HW_FLT | I <sub>OUT</sub> = 1.6mA                     |     |     | 0.4  | V     |
| V <sub>IL</sub>  | LOW-Level Input Voltage<br>ENABLE, S1, S0        |  |     |     | 0.8  | V     |
| V <sub>IH</sub>  | HIGH-Level Input Voltage<br>ENABLE, S1, S0       |  | 2   |     |      | V     |
| I <sub>IH</sub>  | Input Pull-down Current<br>ENABLE, S1, S0        | V <sub>IH</sub> = +0.8V                      | 55  | 80  | 120  | μA    |

Notes:

1. Exceeding the absolute maximum rating may damage the device.

2. The device is not guaranteed to function outside its operating rating.

3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.

4. Specification for packaged product only.

## AC Electrical Characteristics<sup>(4)</sup>

 $V_{CC}$  = +12V,  $C_{REG}$  = 0.1µF,  $T_A$  = +25 °C unless otherwise noted. **Bold** indicates specification applies over the full operating temperature range of 0 °C to +70 °C.

| Symbol                 | Parameter   | Condition   | Min | Тур  | Мах | Units |
|------------------------|---|---|-----|------|-----|-------|
| t <sub>POR</sub>       | Power-on-Reset Delay  | $V_{VREG} \ge V_{VREG(UVLOH)}$  |     |      | 6.5 | ms    |
| t <sub>POCSENSE</sub>  | Primary OC Detector Default<br>Response Time to GATE pin<br>Discharge         | $(V_{VCCSENSE} - V_{SENSE}) = 70$ -mV step;<br>PRIMARY Pin Floating; and<br>S[1:0] = H,L<br>C <sub>GATE</sub> = 100pF | 200 | 300  | 420 | μs    |
| t <sub>SOCSENSE</sub>  | Secondary OC Detector<br>Response Time to GATE Pin<br>Discharge               | (V <sub>VCCSENSE</sub> -V <sub>SENSE</sub> ) = 200-mV step  |     | 0.25 | 0.5 | μs    |
| t <sub>CBRESET</sub>   | Circuit Breaker Reset Delay<br>Time   | ENABLE Low to I_FLT Low   |     |      | 5   | μs    |
| t <sub>ENLPW</sub>     | ENABLE Low Pulse Width  |   | 200 |      |     | μs    |
| t <sub>SCPDETECT</sub> | Shorted C <sub>PRIMARY</sub> Detection<br>Time to HW_FLT Latched              | ENABLE = LOW or HIGH;   |     | 0.25 |     | μs    |
| t <sub>SCPDETPOR</sub> | Shorted C <sub>PRIMARY</sub> Detection<br>Delay after Primary OC<br>Detection | $V_{\text{VCCSENSE}} - V_{\text{SENSE}} \le V_{\text{CBP}}$   |     |      | 6.5 | ms    |
| $t_{\text{DG(FET)}}$   | MOSFET DG Short to<br>HW_FLT Latched  | ENABLE = LOW;<br>GATEFT(EXT) Asserts HW_FLT   |     | 10   |     | μs    |
| $t_{\text{DS(FET)}}$   | MOSFET DS Short to<br>HW_FLT Latched  | ENABLE = LOW;<br>SRCFT(EXT) Asserts HW_FLT  |     | 10   |     | μs    |
|                        | MOSFET DS Short to<br>HW_FLT Latched  | ENABLE = HIGH-to-LOW after<br>steady-state operation  |     | 250  |     | μs    |
|                        |   | ENABLE = HIGH   |     |      |     |       |
|                        |   | DISCH = LOW-to-HIGH   |     |      |     |       |

| Symbol                            | Parameter                              | Condition  | Min | Тур  | Max | Units |
|-----------------------------------|--|--|-----|------|-----|-------|
| t <sub>GLITCH(UVLO)</sub>         | UVLO & OVP Glitch Filter<br>Delay Time | Overdrive = 50mV   |     | 10   |     | μs    |
| $t_{VISS(PROP)}$                  | VISS Propagation Delay<br>Time         | V <sub>VCCSENSE</sub> - V <sub>SENSE</sub> = 0mV to 60mV<br>Capacitance from VISS to GND is<br>100pF                                 |     | 7    |     | μs    |
| $t_{\text{VISS}(\text{RISE})}$    | VISS Rise Time                         | V <sub>VCCSENSE</sub> - V <sub>SENSE</sub> = 0mV to 60mV<br>Capacitance from VISS to GND is<br>100pF<br>V <sub>VISS</sub> 10% to 90% |     | 25   |     | μs    |
| $t_{\text{GLITCH}(\text{PWRGD})}$ | PWRGD Glitch Filter Delay<br>Time      | Overdrive = 250mV  |     | 30   |     | μs    |
| $t_{\text{DLY}(\text{DISCH})}$    | GATE OFF to DISCH Delay<br>Time        |  |     | 0.25 |     | μs    |

#### Notes:

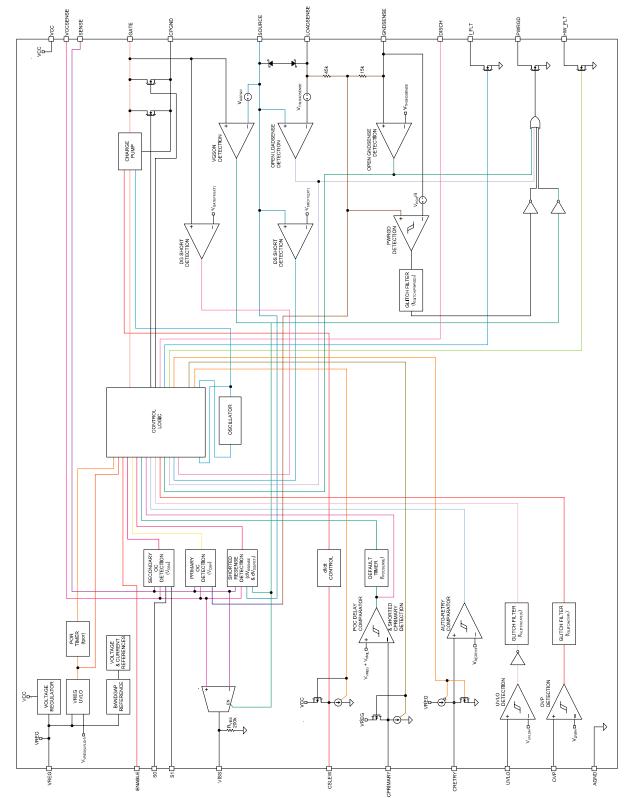
1. Exceeding the absolute maximum rating may damage the device.

2. The device is not guaranteed to function outside its operating rating.

3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.

4. Specification for packaged product only.

## **Block Diagram**



## **Functional Description**

#### Basic Startup Cycle

The basic operation of the MIC2310 is illustrated below in Figure 2 from a cold-start condition. With the applied  $V_{CC}$  supply low such that the internal  $V_{REG}$ voltage is less than the MIC2310's internal V<sub>VREG(UVLOH)</sub> threshold voltage, all state machines are reset, all voltage and current monitor subcircuits are OFF, and the GATE drive circuit is disabled. Digital inputs and all open-drain digital outputs are inactive. When the applied  $V_{\text{CC}}$  supply rises such that the internal V<sub>REG</sub> voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, the t<sub>POR</sub> counter circuit commences. Once the timer terminates, all internal state machines are activated, the CPRIMARY short detection circuit is ON and the DG & DS MOSFET short detection circuits are ON if ENABLE is LOW. The I\_FLT, PWRGD, and HW\_FLT outputs are valid.

Upon the application of an ENABLE LOW-to-HIGH transition after the  $t_{POR}$  delay, or at the end of the  $t_{POR}$  delay if ENABLE is already HIGH, a nominal start-up commences where the dl<sub>D</sub>/dt-controlled inrush current (by dl<sub>D</sub>/dt = 17.6x10<sup>-3</sup> × I<sub>SLEW</sub> / (R<sub>SENSE</sub> ×C<sub>SLEW</sub>)) is permitted to exceed the I<sub>POC</sub> threshold for  $t_{POC}$ , until

there is sufficient charge stored on the load capacitor as evidenced by the output load voltage profile. Note that the secondary overcurrent detection threshold (I<sub>SOC</sub>) is set externally at the controller's S[1:0] pins. Once the inrush current exceeds the Isoc threshold, the circuit breaker trips without delay and the MIC2310 controller shuts down the output. If the inrush current profile does not cause either of the OC detection circuits to trip the circuit breaker and assert the I FLT digital output, the controller will assert the PWRGD digital output when the output load voltage is higher than the controller's V<sub>PGH</sub> threshold voltage and the V<sub>GS</sub> of the external MOSFET is higher than the controller's V<sub>GSPGH</sub> threshold voltage. Due to the low R<sub>DS(ON)</sub> of the external MOSFET, the output load voltage rises with the GATE voltage as the V<sub>GS</sub> of the MOSFET reaches its threshold voltage. Once the output load voltage stabilizes near the V<sub>CC</sub> supply voltage, the V<sub>GS</sub> of the external MOSFET increases above its threshold voltage and eventually exceeds V<sub>GSPGH</sub>. The PWRGD output asserts to signal that the external MOSFET is fully enhanced and ready for the application of the full load.

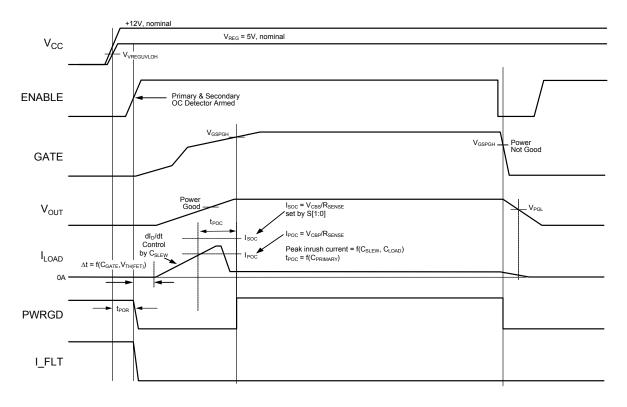


Figure 2. Basic Startup Cycle

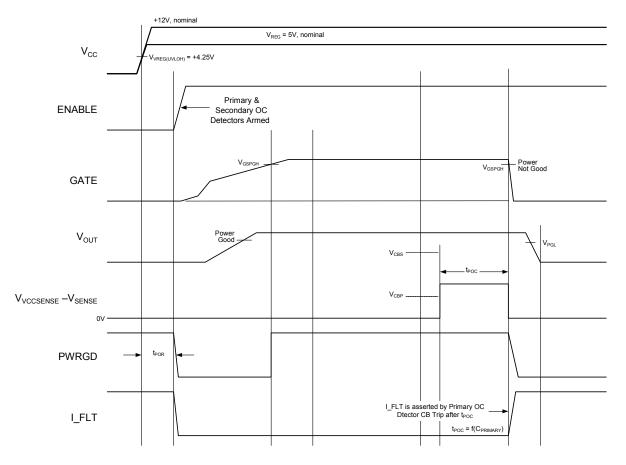
# Primary Overcurrent (OC) Detector Trips Circuit Breaker and Asserts I\_FLT

Figure 3 below illustrates the behavior of the controller to an OC event after the primary and secondary OC detection circuits have been armed (upon the application of an ENABLE LOW-to-HIGH transition and after  $t_{POR}$ ) and steady-state operation has been achieved. Note that the assertion of the controller's PWRGD digital output occurs when the output load voltage profile is higher than the controller's V<sub>PGH</sub> threshold voltage and the V<sub>GS</sub> of the external MOSFET is higher than the controller's V<sub>GSPGH</sub> threshold voltage.

The use of an external C<sub>PRIMARY</sub> capacitor sets the response time, t<sub>POC</sub>, of the primary OC detector according to the internal V<sub>PRIL</sub> threshold voltage and the CPRIMARY pin discharging current, I<sub>PRI</sub>, where t<sub>POC</sub> = t<sub>POCSENSE</sub> + C<sub>PRIMARY</sub> \* (V<sub>PRIL</sub>/I<sub>PRI</sub>). Prior to triggering the primary OC detector (i.e., when V<sub>VCCSENSE</sub> -V<sub>SENSE</sub> < V<sub>CBP</sub>), a 3mA current source is enabled to hold the CPRIMARY pin voltage to the internally-generated V<sub>REG</sub> voltage. When the primary

OC detector has been triggered, the 3mA current source is first disabled and a  $3\mu$ A current sink is enabled to discharge the external C<sub>PRIMARY</sub>. When C<sub>PRIMARY</sub> has discharged below V<sub>PRIL</sub>, a default timer is enabled. Once the default timer (t<sub>POCSENSE</sub>) times out, the circuit breaker is tripped, the  $3\mu$ A current sink is disabled, and the 3mA current source is enabled to discharge C<sub>PRIMARY</sub> back to V<sub>REG</sub> quickly. Concurrently, the GATE drive circuit is disabled and a higher current, fault-mode pull-down current sink is enabled at the GATE pin. The DISCH output goes high to (optionally) drive external pull-down circuitry.

In the event that the CPRIMARY pin is left NC (intentionally or otherwise), the overcurrent timer default value is  $t_{POCSENSE}$  (250µs typical), as specified in the ac specification table. Once the circuit breaker is latched, the I\_FLT digital output is asserted and the PWRGD digital output becomes de-asserted when the output voltage profile falls below the controller's V<sub>PGL</sub> threshold voltage or the V<sub>GS</sub> of the external MOSFET falls below the controller's V<sub>GSPGH</sub> threshold voltage.





# Secondary OC Detector Trips Circuit Breaker and Asserts I\_FLT

Figure 4 illustrates the behavior of the controller to an OC event after the primary and secondary OC detection circuits have been armed (upon the application of an ENABLE LOW-to-HIGH transition and after  $t_{POR}$ ) and steady-state operation has been achieved. Note that the assertion of the controller's PWRGD digital output occurs when the output load voltage profile is higher than the controller's V<sub>PGH</sub> threshold voltage and the V<sub>GS</sub> of the external MOSFET is higher than the controller's V<sub>GSPGH</sub> threshold voltage.

The controller's secondary OC detection threshold is set by the status of the controller's S[1:0] pins and its response time is internally set at  $t_{\text{SOCSENSE}}$  as shown in

the ac specification table. When the secondary OC detector has sensed a very large current surge  $(V_{CCSENSE} - V_{SENSE} \ge V_{CBS})$ , the circuit breaker is tripped within  $t_{SOCSENSE}$ . Concurrently, the GATE drive circuit is disabled and a higher current, fault-mode pull-down current sink is enabled at the GATE pin. The DISCH output goes high to (optionally) drive external pull-down circuitry.

Once the circuit breaker is latched, the I\_FLT digital output is asserted and the PWRGD digital output becomes de-asserted when the output voltage profile falls below the controller's  $V_{PGL}$  threshold voltage or the  $V_{GS}$  of the external MOSFET falls below the controller's  $V_{GSPGH}$  threshold voltage.

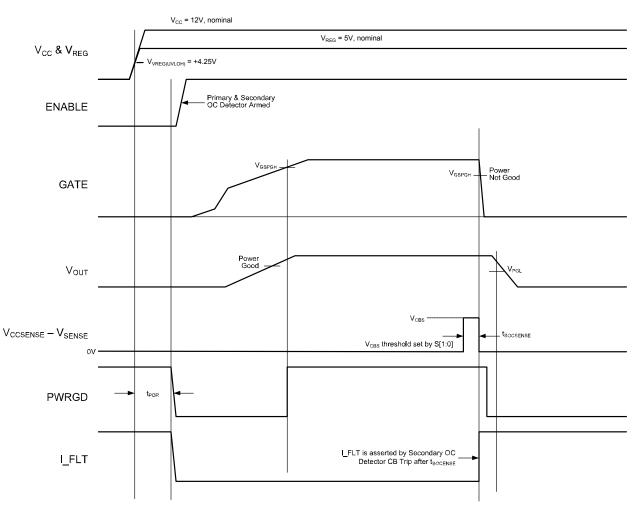


Figure 4. Secondary OC Detector Trips Circuit Breaker

#### Charging Load by dl<sub>D</sub>/dt – Primary OC Trips CB after t<sub>POC</sub> and CB Reset by Toggling ENABLE HIGH-to-LOW

Figure 5 illustrates the behavior of the controller to an OC event after the primary and secondary OC detection circuits have been armed (upon the application of an ENABLE LOW-to-HIGH transition and after  $t_{POR}$ ). In this example, the load capacitor is charged at a controlled dl<sub>D</sub>/dt rate. Steady-state operation is not achieved as the controlled inrush profile causes the primary OC detector to trigger at  $I_{POC}$  and continues charging when the  $t_{POCSENSE}$  timer terminates. Note that the controller's PWRGD digital output does not assert because the output load

voltage profile at no time rises higher than the controller's  $V_{PGH}$  threshold voltage and the  $V_{GS}$  of the external MOSFET does not rise higher than the controller's  $V_{GSPGH}$  threshold voltage.

Once the circuit breaker has latched, the I\_FLT digital output is asserted. When the circuit breaker is tripped by either the primary OC or secondary OC detectors), applying a HIGH-to-LOW transition on the ENABLE pin will reset the circuit breaker. At a delay defined by  $t_{CBRESET}$ , the internal circuit breaker is reset and is indicated when the I\_FLT digital output becomes deasserted. The earliest a LOW-to-HIGH transition at ENABLE is permitted to initiate a new start-up sequence is defined by the  $t_{ENLPW}$  timing specification.

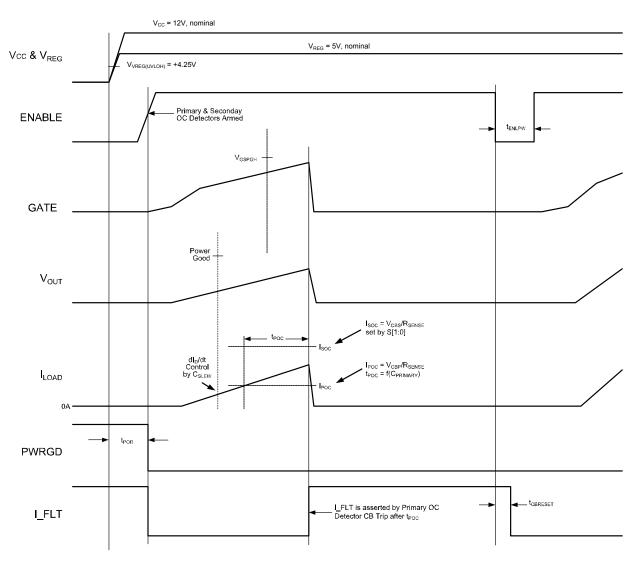


Figure 5. dl<sub>D</sub>/dt Load Charge Profile w/ Primary OC Circuit Breaker (CB) Trip w/ CB Reset

#### Primary OC Trips Circuit Breaker (CB) and CB Resets with C<sub>RETRY</sub> (Auto-Retry Timing Capacitor)

Figure 6 illustrates the behavior of the controller to a primary OC event when a CRETRY capacitor is used to automatically reset the circuit breaker. The automatic reset operation is the same for the case of a secondary OC event. In this example, the primary and secondary OC detection circuits have been armed (upon the application of an ENABLE LOW-to-HIGH transition and after t<sub>POR</sub>) and the load capacitor is charged at a controlled dl<sub>D</sub>/dt rate. Note that in this diagram, ENABLE is tied to  $V_{CC}$  and rises with  $V_{CC}$ . Steady-state operation is achieved as the controller's PWRGD digital output is asserted when the output load voltage profile is higher than the controller's V<sub>PGH</sub> threshold voltage and the V<sub>GS</sub> of the external MOSFET is higher than the controller's V<sub>GSPGH</sub> threshold voltage.

When the primary OC detector has been triggered by an output current exceeding  $I_{POC}$  for a time  $t_{POC}$ , the circuit breaker is tripped, the GATE drive circuit is disabled, the fault-mode pull-down current sink is enabled at the GATE pin, the DISCH output goes high, and the I\_FLT digital output becomes asserted. The use of an external CRETRY capacitor sets the autoretry time, t<sub>RETRY</sub>, according to the internal V<sub>RETRYH</sub> threshold voltage and the CRETRY pin charging current,  $I_{RETRYUP}$  [ $t_{RETRY} = C_{RETRY} * (V_{RETRYH}/I_{RETRYUP})$ ]. Prior to the tripping of the OC circuit breaker, a 3mA current sink is enabled holding the CRETRY pin voltage at 0V. When the OC circuit breaker has been tripped, the 3mA current sink is disabled and a 3µA current source is enabled to charge the external C<sub>RETRY</sub> capacitor. When C<sub>RETRY</sub> has charged above V<sub>RETRYH</sub>, the circuit breaker is reset such that the I FLT digital output is de-asserted. Additionally, the 3µA current source is disabled and the 3mA current sink is enabled to discharge the CRETRY pin voltage back to 0V. When CRETRY has discharged below V<sub>RETRYL</sub>, the GATE drive circuit is re-enabled and the DISCH output returns low. For the case of a persistent overcurrent load, the controller will continuously cycle between starting up into an OC condition that trips the circuit breaker and the auto-retry time before the circuit breaker is reset.

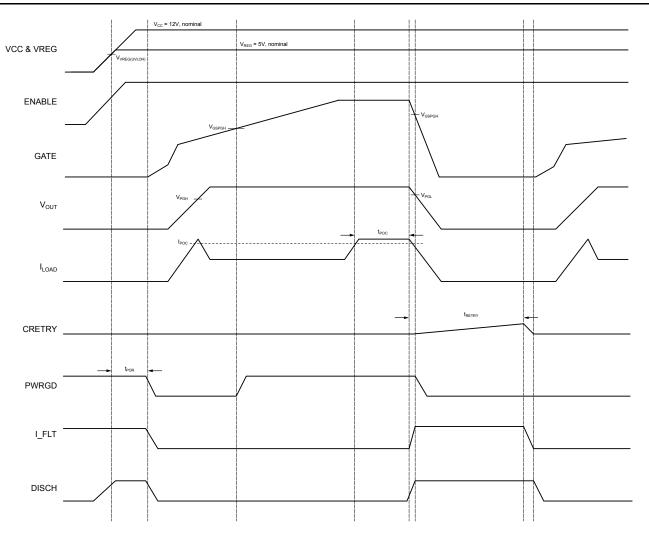


Figure 6. Primary Overcurrent Fault with Auto-Retry to Reset the Circuit Breaker

#### HW\_FLT Digital Output Asserted by a MOSFET DG Short with ENABLE = LOW

In order to protect the system from the result of the installation of a damaged MOSFET on the PCB, the controller incorporates a MOSFET shorted DG detection scheme whose operation is described in Figure 7. With the applied  $V_{CC}$  supply high such that the internal  $V_{REG}$  voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, an elapsed POR timer, and with the ENABLE input LOW, a weak current sink at the GATE pin attempts to hold the GATE voltage at 0V. If there is a DG short on the MOSFET, the weak

current sink is not capable of holding the voltage at 0V as the GATE voltage tracks the MOSFET's DRAIN voltage. The voltage monitor circuit at the controller's GATE pin will be triggered once the GATE voltage crosses the  $V_{GATEFT(EXT)}$  threshold voltage. The HW\_FLT digital output is subsequently asserted within a delay approximately equal to the delay in the logic circuits – no additional timing circuit is required. To clear the latched GATE voltage monitor circuit and to reset the HW\_FLT digital output, the applied V<sub>CC</sub> supply voltage must fall such that V<sub>REG</sub> is below the controller's V<sub>VREG(UVLOL</sub> threshold voltage.

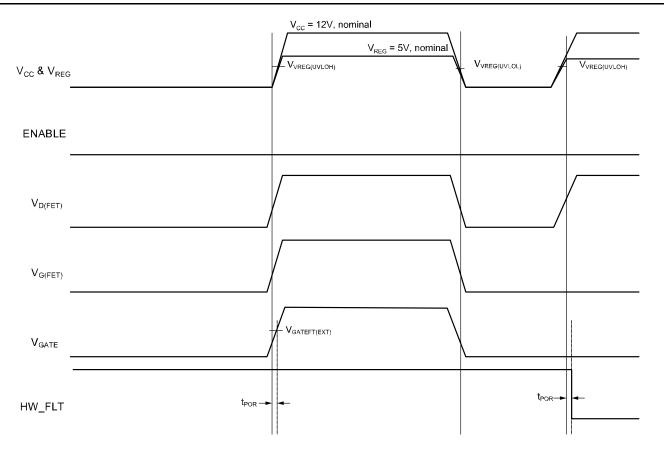
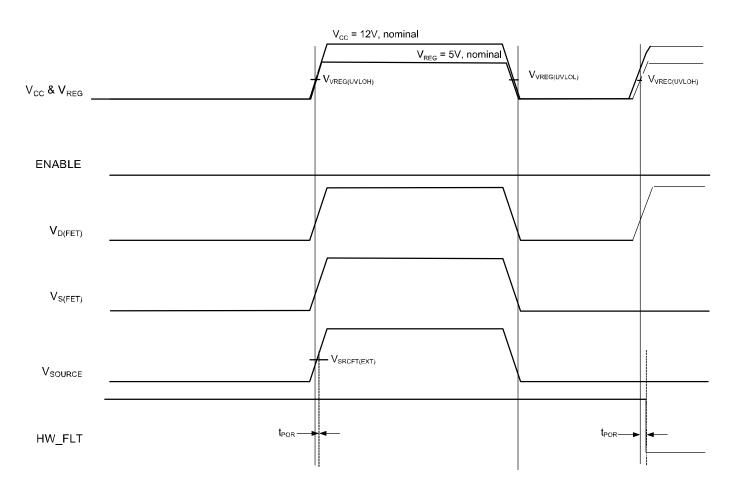


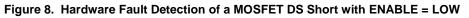
Figure 7. Hardware Fault Detection of a MOSFET DG Short with ENABLE = LOW

#### HW\_FLT Digital Output Asserted by MOSFET DS Short with ENABLE = LOW

In order to protect the system from the result of the installation of a damaged MOSFET on the PCB, the controller incorporates a MOSFET shorted DS detection scheme whose operation is described in Figure 8. With the applied  $V_{CC}$  supply high such that the internal  $V_{REG}$  voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, an elapsed POR timer, and with the ENABLE input LOW, a voltage monitor circuit for the controller's SOURCE pin is enabled. If there is a DS short on the MOSFET, the external load on the MOSFET is not capable of holding the voltage

at 0V as the SOURCE voltage tracks the MOSFET's DRAIN voltage. The voltage monitor circuit at the controller's SOURCE pin will be triggered once the SOURCE voltage crosses the  $V_{SRCFT(EXT)}$  threshold voltage. The HW\_FLT digital output is subsequently asserted within a delay approximately equal to the delay in the logic circuits – no additional timing circuit is required. To clear the latched source voltage monitor circuit and to reset the HW\_FLT digital output, the applied V<sub>CC</sub> supply voltage must fall such that V<sub>REG</sub> is below the controller's V<sub>VREG(UVLOL)</sub> threshold voltage.





#### HW\_FLT Asserted by MOSFET DS Short after Steady-state Operation then ENABLE = HIGH-to-LOW

Figure 9 illustrates the behavior of the controller to a shorted DS MOSFET condition after steady-state operation is achieved via a nominal start-up. Note that the load capacitor at start-up was charged in a controlled dI<sub>D</sub>/dt mode and assertion of the controller's PWRGD digital output occurs when the output load voltage profile is higher than the controller's V<sub>PGH</sub> threshold voltage and the V<sub>GS</sub> of the external MOSFET is higher than the controller's V<sub>GSPGH</sub> threshold voltage. Upon the application of a HIGH-to-LOW transition on ENABLE by the service processor, the GATE drive circuit is disabled, the weak GATE

current sink is enabled, the DISCH output goes high, and the  $t_{DS-SSFAULT}$  timer is started. With the ENABLE input LOW, a voltage monitor circuit for the controller's SOURCE pin (i.e.,  $V_{OUT}$ ) is enabled. If there is a DS short, the voltage at the source will not drop to 0V even though the GATE is OFF. If the output voltage at the SOURCE pin remains higher than the controller's  $V_{SRCFT(EXT)}$  threshold voltage when the  $t_{DS-SSFAULT}$  timer terminates, the HW\_FLT digital output is asserted. To repair the damaged MOSFET and to reset the HW\_FLT digital output and the controller, the service processor instructs the main supply to turn off the  $V_{CC}$  supply voltage to the controller such that  $V_{REG}$  falls below the controller's  $V_{VREG(UVLOL)}$  threshold voltage.

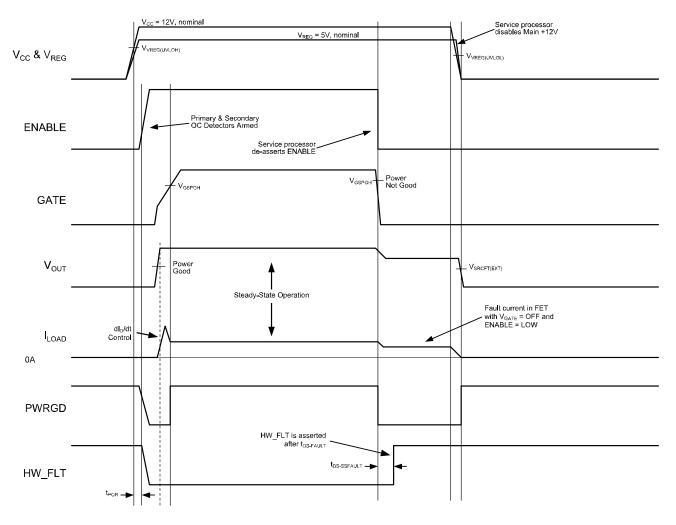


Figure 9. Hardware Fault by a MOSFET DS Short after Steady-State Operation (ENABLE = HIGH-to-LOW)

# HW\_FLT Asserted by MOSFET DS Short after Steady-state Operation then a Fault Condition

Figure 10 illustrates the behavior of the controller to a shorted DS MOSFET condition after steady-state operation is achieved via a nominal start-up. With the occurrence of one of the following fault conditions – UVLO, OVP, primary OC, secondary OC, open LOADSENSE, or open GNDSENSE - the GATE drive circuit is disabled, the GATE fault-mode pull-down current sink is enabled, the DISCH output goes high, and the  $t_{DS-SSFAULT}$  timer is started. The occurrence of a primary OC fault condition is shown here. The

voltage monitor circuit for the controller's SOURCE pin is also enabled. If there is a DS short, the voltage at the source will not drop to 0V even though the GATE is OFF. If the output voltage at the SOURCE pin remains higher than the controller's  $V_{SRCFT(EXT)}$  threshold voltage when the  $t_{DS-SSFAULT}$  timer terminates, the HW\_FLT digital output is asserted. To repair the damaged MOSFET and to reset the HW\_FLT digital output and the controller, the service processor instructs the main supply to turn off the V<sub>CC</sub> supply voltage to the controller such that V<sub>REG</sub> falls below the controller's V<sub>VREG(UVLOL</sub> threshold voltage.

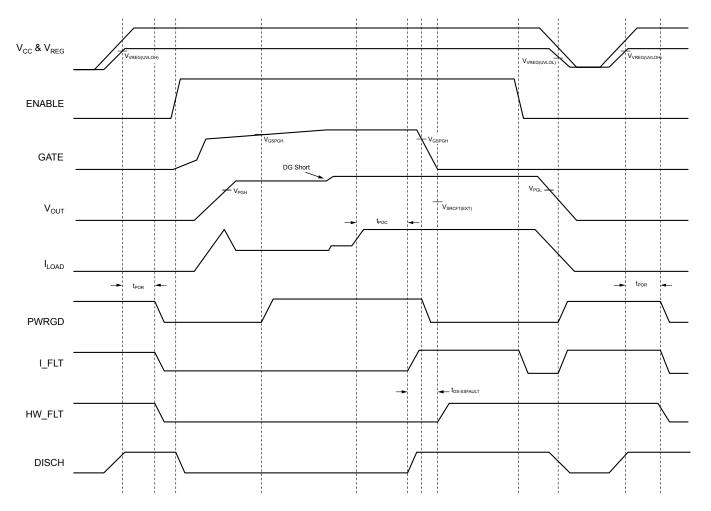


Figure 10. HW\_FLT Asserted by a MOSFET DS Short after Steady-State Operation then a Fault Condition

#### Shorted R<sub>SENSE</sub> Detector Trips CB and Asserts HW\_FLT

In order to protect the system from the result of the installation of a shorted sense resistor on the PCB, which would increase the effective OC detection thresholds to unsafe levels, the controller incorporates a shorted  $R_{SENSE}$  detection scheme whose operation is described in Figure 11. The  $R_{SENSE}$  detection circuitry is enabled upon the application of an ENABLE LOW-to-HIGH transition, an elapsed POR timer, and the V<sub>GS</sub> of the external MOSFET being higher than the controller's V<sub>GSPGH</sub> threshold voltage. Note that for the case of a shorted sense resistor, dl<sub>D</sub>/dt control of the inrush current is disabled and the controller defaults to dV<sub>GATE</sub>/dt control of the GATE voltage.

An  $R_{\text{SENSE}}$  short is detected by comparing the  $V_{\text{RS}}$  voltage drop across the sense resistor

 $(V_{\text{CCSENSE}}\text{-}V_{\text{SENSE}})$  to the  $V_{\text{DS}}$  voltage drop across the external MOSFET ( $V_{\text{SENSE}}\text{-}V_{\text{SOURCE}}$ ). To avoid a false

 $R_{SENSE}$  short detection at low current, a minimum  $V_{DS}$ of  $\Delta V_{DS(FET)}$  must exist across the external MOSFET for a shorted sense resistor to be detected. For larger values of V<sub>DS</sub> across the external MOSFET generated by higher load currents, the  $\Delta V_{RSENSE}$  threshold voltage for the detection of an R<sub>SENSE</sub> short follows the equation  $\Delta V_{RSENSE} = 0.5 * (V_{DS} - \Delta V_{DS(FET)})$ . If there exists a short across the sense resistor such that  $V_{RS}$ drops below the  $\Delta V_{RSENSE}$  threshold voltage, then an internal circuit breaker is tripped, the GATE drive circuit is disabled, the GATE fault-mode pull-down current sink is enabled, the DISCH output goes high, and the HW FLT digital output is asserted. To repair the damaged sense resistor and reset the HW FLT digital output, the service processor instructs the main supply to turn off the V<sub>CC</sub> supply voltage to the controller such that V<sub>REG</sub> falls below the controller's  $V_{VREG(UVLOL)}$  threshold voltage.

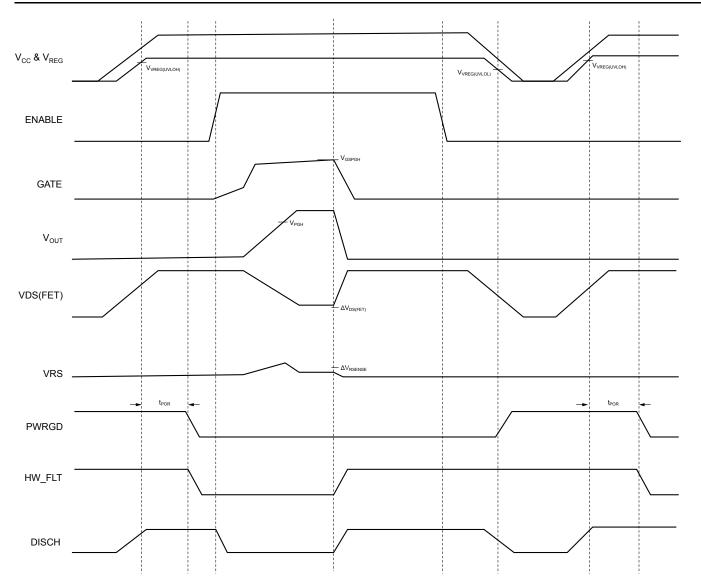
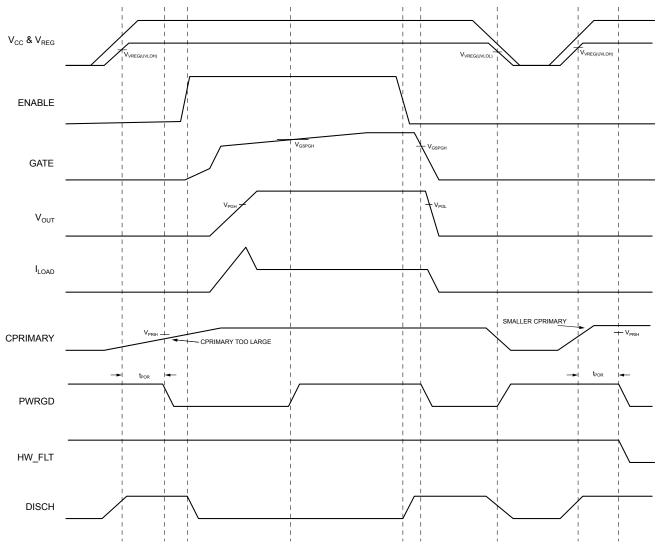


Figure 11. Shorted  $R_{\mbox{\scriptsize SENSE}}$  Trips Circuit Breaker and Asserts HW\_FLT

# Shorted C<sub>PRIMARY</sub> Detector Asserts HW\_FLT at Start-up

In order to protect the system from the result of the installation of a shorted or excessively large  $C_{PRIMARY}$  capacitor on the PCB, the controller incorporates a shorted  $C_{PRIMARY}$  detection scheme. A shorted CPRIMARY pin or an excessively large  $C_{PRIMARY}$  capacitor will impact the primary OC detection time, t<sub>POC</sub>. The operation of the shorted  $C_{PRIMARY}$  detection scheme at start-up is described in Figure 12. Prior to power-up, the CPRIMARY pin is discharged to 0V. As the applied V<sub>CC</sub> supply and the internal V<sub>REG</sub> voltage rise, a 3mA current source is applied to the CPRIMARY pin to charge  $C_{PRIMARY}$  to V<sub>REG</sub>. When the internal V<sub>REG</sub> voltage is above the controller's V<sub>VREG(UVLOH)</sub> threshold voltage, the t<sub>POR</sub> timer is initiated. For the case of a reasonable  $C_{PRIMARY}$ 

capacitor value, one which keeps the primary OC response time, t<sub>POC</sub>, less than 0.5s, C<sub>PRIMARY</sub> charges above V<sub>PRIH</sub> before the POR timer terminates and normal operation commences. However, if the CPRIMARY pin is shorted to GND or CPRIMARY is too large, as in this timing diagram, the POR timer terminates before C<sub>PRIMARY</sub> charges above V<sub>PRIH</sub> and a shorted C<sub>PRIMARY</sub> is detected. When a C<sub>PRIMARY</sub> short is detected, the GATE drive circuit and the DISCH output are not affected, however, the HW FLT digital output is asserted. To repair the damaged C<sub>PRIMARY</sub> capacitor and reset the HW\_FLT digital output, the service processor instructs the main supply to turn off the  $V_{CC}$  supply voltage to the controller such that  $V_{REG}$ falls below the controller's V<sub>VREG(UVLOL)</sub> threshold voltage.





## Shorted C<sub>PRIMARY</sub> Detector Asserts HW\_FLT during Steady-state

Figure 13 illustrates the behavior of the controller to a shorted  $C_{PRIMARY}$  capacitor condition after steady-state operation is achieved via a nominal start-up. If a  $C_{PRIMARY}$  short occurs during steady-state operation, the CPRIMARY pin voltage will drop below the  $V_{PRIL}$  threshold voltage and a shorted  $C_{PRIMARY}$  is detected. When a  $C_{PRIMARY}$  short is detected, the GATE drive

circuit remains enabled and the DISCH output remains low such that the external MOSFET remains ON, however, the HW\_FLT digital output is asserted. To repair the damaged  $C_{\text{PRIMARY}}$  capacitor and reset the HW\_FLT digital output, the service processor instructs the main supply to turn off the V<sub>CC</sub> supply voltage to the controller such that V<sub>REG</sub> falls below the controller's V<sub>VREG(UVLOL</sub> threshold voltage.

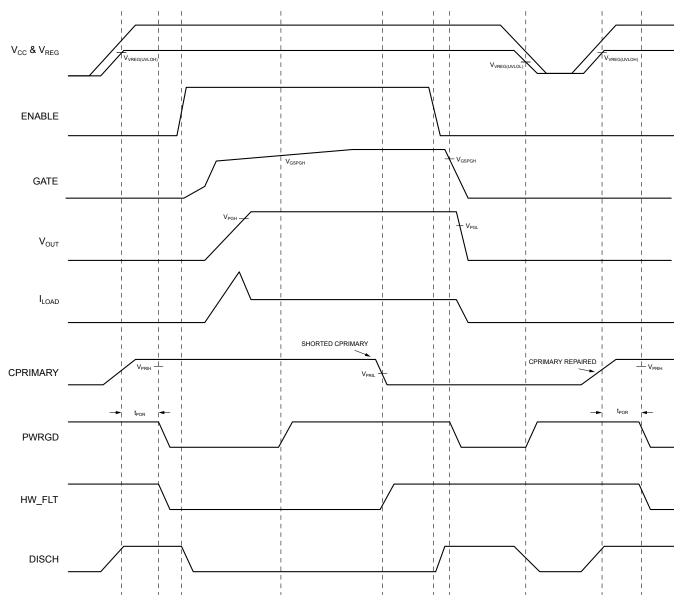


Figure 13. Shorted  $C_{PRIMARY}$  Detector Asserts HW\_FLT During Steady-State

#### Shorted C<sub>PRIMARY</sub> Detector Asserts HW\_FLT After Primary OC Event

The diagram in Figure 14 illustrates the behavior of the controller to a shorted C<sub>PRIMARY</sub> capacitor condition after steady-state operation is achieved via a nominal start-up and after a primary OC event has occurred. As described previously, during a primary OC event, the CPRIMARY capacitor is discharged as part of setting the primary OC detector response time, t<sub>POC</sub>. In order to prevent a false C<sub>PRIMARY</sub> short detection from occurring while the CPRIMARY pin is being intentionally discharged, the C<sub>PRIMARY</sub> short detection circuit is disabled when the primary OC detector detects an overcurrent. In addition, the CPRIMARY short detection circuit is not re-enabled until after a time delay, t<sub>SCPDETPOR</sub>, once the primary OC detector no longer detects an overcurrent. This delay time should allow a capacitor of reasonable size to be charged back up above V<sub>PRIH</sub>, even if it has been discharged to 0V, such that a false C<sub>PRIMARY</sub> short is not indicated when the  $C_{\mbox{\scriptsize PRIMARY}}$  short detection circuitry is reenabled.

In the timing diagram, CPRIMARY becomes shorted during the primary OC event. When the CPRIMARY pin voltage falls below V<sub>PRIL</sub>, the t<sub>POCSENSE</sub> timer is enabled. Once this timer times out, the circuit breaker is tripped, I FLT is asserted, the GATE drive circuitry is disabled, the GATE fault-mode pull-down current sink is enabled, and the DISCH output goes high. As the external MOSFET is turned OFF, the output current drops and an overcurrent condition is no longer detected. This initiates the t<sub>SCPDETPOR</sub> timer. Since C<sub>PRIMARY</sub> does not charge back up above V<sub>PRIH</sub> before this timer expires, HW FLT is asserted after the t<sub>SCPDETPOR</sub> time. To repair the damaged C<sub>PRIMARY</sub> capacitor and reset the HW FLT digital output, the service processor instructs the main supply to turn off the  $V_{\text{CC}}$  supply voltage to the controller such that  $V_{\text{REG}}$ falls below the controller's V<sub>VREG(UVLOL)</sub> threshold voltage.

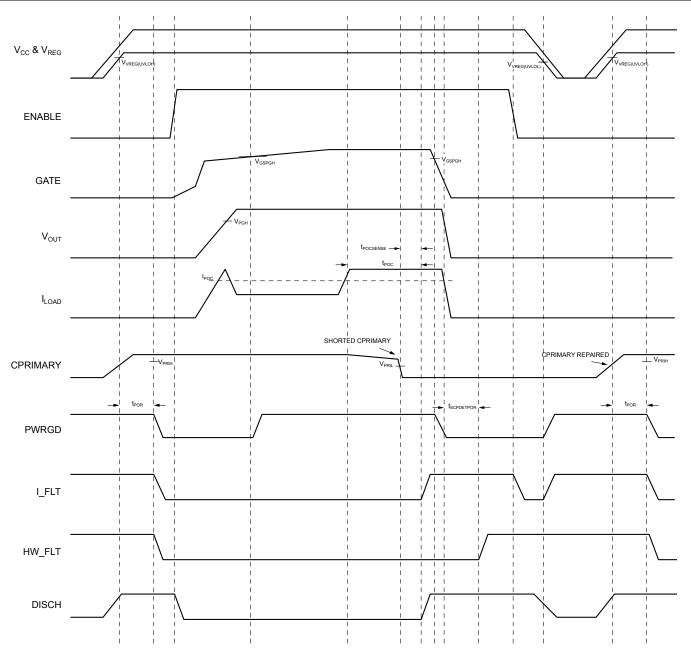
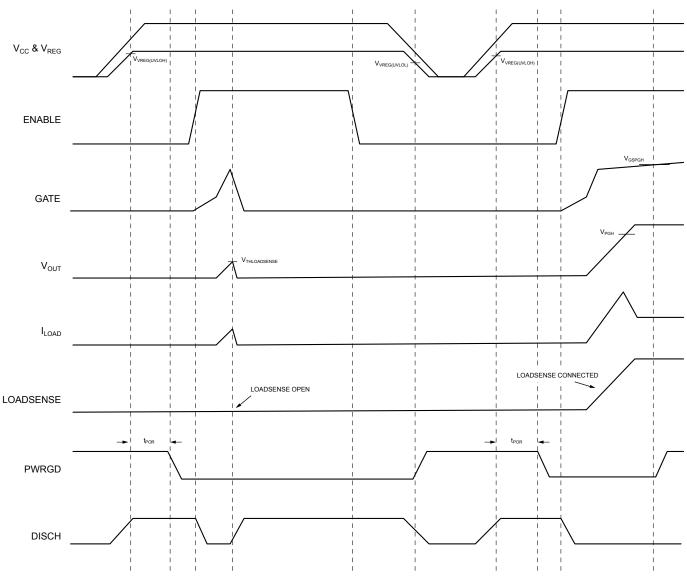


Figure 14. Shorted  $C_{PRIMARY}$  Detector Asserts HW\_FLT after Primary OC Event

#### Open LOADSENSE Detector Trips CB

In order to protect the system from the result of an open LOADSENSE pin, the controller incorporates an open LOADSENSE detection scheme. An open LOADSENSE pin could result in the effective primary OC detection threshold being at an unsafe level. The timing diagram in Figure 15 describes the operation of this function. With the applied  $V_{CC}$  supply high such that the internal  $V_{REG}$  voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, an elapsed POR timer, and with the application of an ENABLE LOW-to-HIGH transition, the GATE drive circuitry is enabled and the GATE voltage begins to rise. As the external MOSFET turns ON, the SOURCE voltage begins to rise also. Normally, the LOADSENSE voltage would rise with the SOURCE voltage. However, if the

LOADSENSE pin is open, the LOADSENSE voltage will remain at a lower voltage due to the load of other internal circuitry. An open LOADSENSE pin is detected by comparing the voltage at the SOURCE pin to the voltage at the LOADSENSE pin. Once the voltage at the SOURCE pin differs from the voltage at the SOURCE pin by  $V_{THLOADSENSE}$ , a circuit breaker is tripped, the GATE drive circuitry is disabled, the GATE fault-mode pull-down current sink is enabled, and the DISCH output goes high. This circuit breaker can be reset, such that the GATE drive circuitry can be re-enabled, by either a HIGH-to-LOW transition on ENABLE or turning off the V<sub>CC</sub> supply voltage to the controller such that  $V_{REG}$  falls below the controller's  $V_{VREG(UVLOL)}$  threshold voltage.

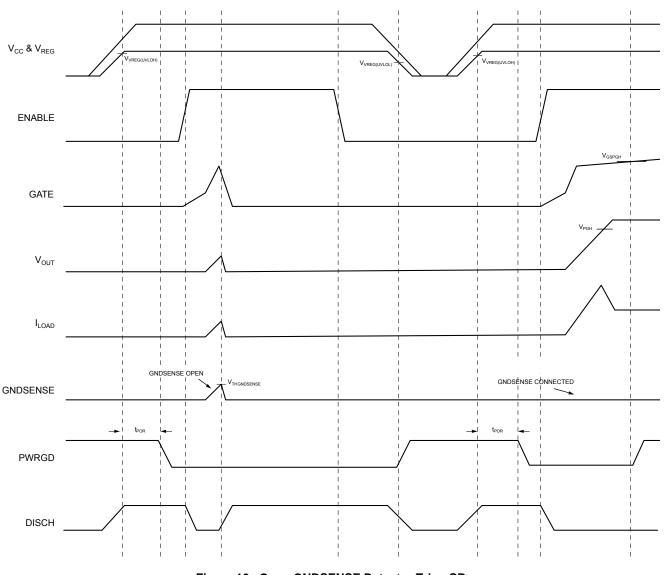




#### **Open GNDSENSE Detector Trips CB**

In order to protect the system from the result of an open GNDSENSE pin, the controller incorporates an open GNDSENSE detection scheme. An open GNDSENSE pin could result in the effective primary OC detection threshold being at an unsafe level. The timing diagram in Figure 16 describes the operation of this function. With the applied  $V_{CC}$  supply high such that the internal  $V_{REG}$  voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, an elapsed POR timer, and with the application of an ENABLE LOW-to-HIGH transition, the GATE drive circuitry is enabled and the GATE voltage begins to rise. As the external MOSFET turns ON, the SOURCE voltage begins to rise also and the LOADSENSE voltage follows the SOURCE voltage. Normally, the GNDSENSE pin

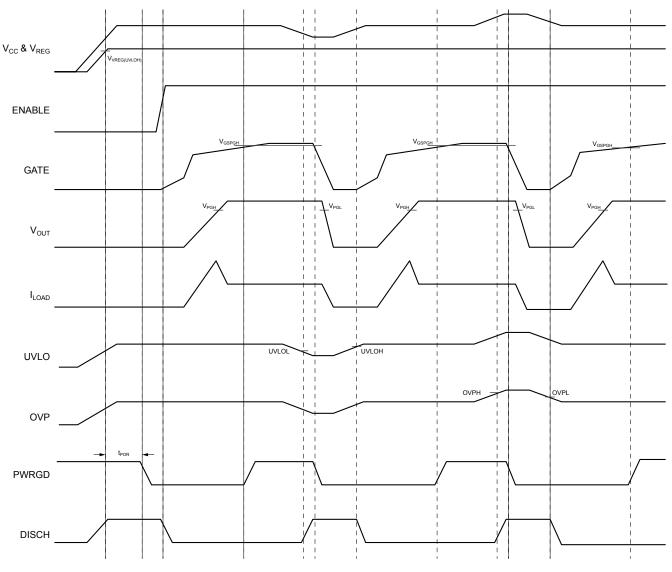
would remain at 0V. However, if the GNDSENSE pin is open, the GNDSENSE voltage will rise due to the load of other internal circuitry. An open GNDSENSE pin is detected by comparing the voltage at the GNDSENSE pin to the voltage at the AGND pin. Once the voltage at the GNDSENSE pin differs from the voltage at the AGND pin by V<sub>THGNDSENSE</sub>, a circuit breaker is tripped, the GATE drive circuitry is disabled, the GATE fault-mode pull-down current sink is enabled, and the DISCH output goes high. This circuit breaker can be reset, such that the GATE drive circuitry can be re-enabled, by either a HIGH-to-LOW transition on ENABLE or turning off the V<sub>CC</sub> supply voltage to the controller such that V<sub>REG</sub> falls below the controller's V<sub>VREG(UVLOL</sub> threshold voltage.

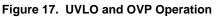




#### UVLO and OVP Operation

The system can be protected against an undervoltage condition or an over-voltage condition on the  $V_{CC}$  supply by using an external resistor divider and the UVLO and OVP pins, respectively. Figure 17 illustrates the timing of the GATE and digital pin outputs when the input supply crosses the UVLO and OVP thresholds. When the voltage applied to the UVLO pin is less than the V<sub>UVLOL</sub> threshold voltage or the voltage applied to the OVP pin is greater than the  $V_{\text{OVPH}}$  threshold voltage, the GATE drive circuitry is disabled, the GATE fault-mode pull-down current sink is enabled, and the DISCH output goes high. Increasing  $V_{\text{CC}}$  such that the voltage applied to the UVLO pin increases above  $V_{\text{UVLOH}}$  or decreasing  $V_{\text{CC}}$  such that the voltage applied to the OVP decreases below  $V_{\text{OVPL}}$  re-enables the GATE drive circuit and forces the DISCH output low, allowing the controller to return to normal operation.





#### **VISS Output Operation**

The VISS output provides a voltage which is proportional to the output current flowing in the external sense resistor. Figure 18 illustrates the operation of this output. With the applied  $V_{CC}$  supply high such that the internal  $V_{REG}$  voltage is above the controller's  $V_{VREG(UVLOH)}$  threshold voltage, an elapsed POR timer, and with the application of an ENABLE LOW-to-HIGH transition, the GATE drive circuitry is enabled. When the output load voltage profile is higher than the controller's  $V_{PGH}$  threshold voltage and the  $V_{GS}$  of the external MOSFET is higher than the controller's  $V_{GSPGH}$  threshold voltage, the PWRGD

digital output is asserted and the VISS output becomes active. The current flowing in the external sense resistor is determined by sensing the voltage across the sense resistor ( $V_{CCSENSE}$ - $V_{SENSE}$ ). As the output current varies under changing load conditions,  $V_{CCSENSE}$ - $V_{SENSE}$  also varies and the VISS output voltage changes proportionally according to  $V_{ISS(SENS)}$ . When the external MOSFET is disabled, either by a HIGH-to-LOW transition on ENABLE or due to a fault condition, the  $V_{GS}$  of the external MOSFET falls below the controller's  $V_{GSPGH}$  threshold voltage. This causes the PWRGD digital output to be de-asserted and the VISS output to be disabled.

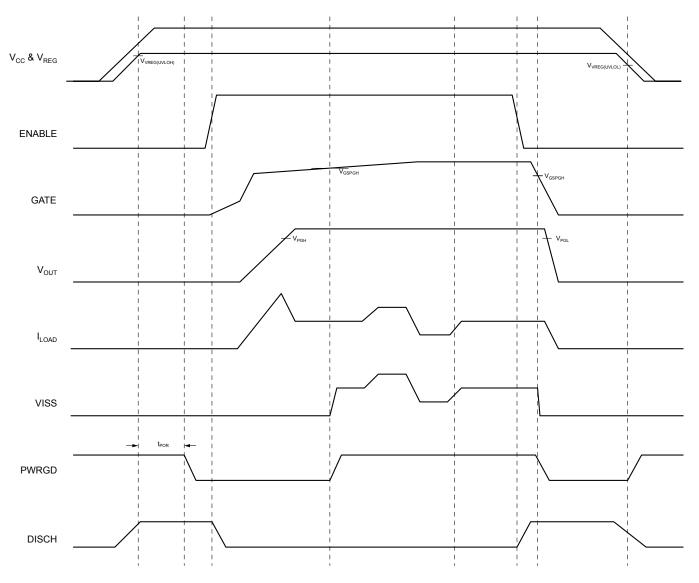
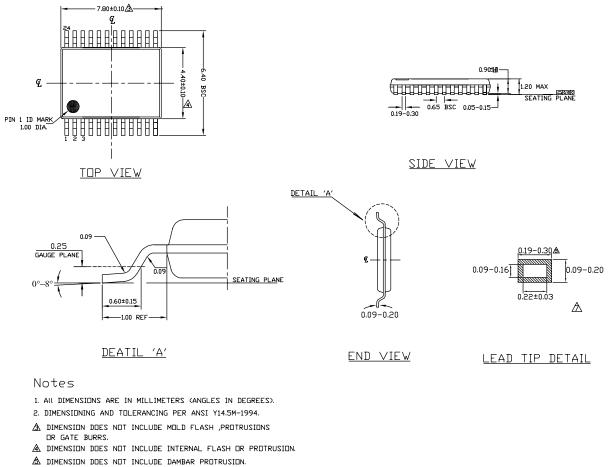


Figure 18. VISS Operation

## Applications Information

The MIC2310 can be configured to address powerlimiting applications other than the 240-VA power control (UL60950 Safe Power Handling Systems). There are two key requirements to consider in selecting the external components for use in various power-limit applications: 1) The value (and tolerance) of the  $R_{SENSE}$  current sensing resistor; and 2) The  $R_{DS(ON)}$  of the external Power MOSFET. These two components are vital with regards to the shorted  $R_{SENSE}$  detection scheme such that the values of each need to be chosen such that variations in  $R_{DS(ON)}$  and  $R_{SENSE}$  over process, supply, and temperature does not result in a false  $R_{SENSE}$  short detection. In short, the value of  $R_{DS(ON)}$  of the external MOSFET should be selected to not exceed twice the value of  $R_{SENSE}$  over process, supply, and temperature, to avoid the generation of a false  $R_{SENSE}$  short detection.

### **Package Information**



▲ CROSS SECTION TO BE DETERMINED AT 0.10 TO 0.25MM FROM THE LEAD TIP.

24-Pin TSSOP (TS)

#### MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB http://www.micrel.com

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